

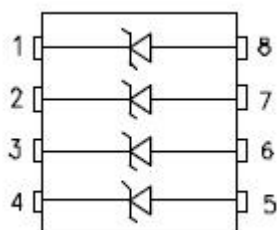
SMDA03 THRU SMDA36 TVS ARRAY SERIES



Description

The SMDAXX series of TVS array have been designed to provide unidirectional protection for sensitive electronics from damage due to voltage transients caused by electrostatic discharge (ESD), electrical fast transients (EFT), lightning and other voltage-induced transient events. The device can be used to protect combinations of four unidirectional lines.

Schematic & Pin Configuration



Features

- Protects 3.3, 5, 12, 15, 24, 36 V Components
- Unidirectional
- Provides Electrically Isolated Protection
- 300 W @ 8/20 us
- Protects 4 Lines
- SO-8 Packaging
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Characteristics

- SO-8 Surface Mount Package
- Approximate Weight: 0.1 grams
- PIN #1 Indicator: DOT on top of package
- Packaging: Tubes or Tape & Reel per EIA Standard 481

Application

- RS-232 Data Lines
- Microprocessor Based Equipment
- Notebooks, Desktops, & Servers
- LAN/WAN Equipment
- Serial and Parallel Port
- Peripherals

Absolute Maximum Ratings:

Parameter	Symbol	Value	Units
Peak Pulse Power, 8/20 μ s Wave shape	P	300	W
Operating Temperature	T _J	-55 to +125	°C
Storage Temperature	T _{stg}	-55 to +150	°C
Lead Soldering Temperature	T _L	260 (10 Sec.)	°C

Electrical Characteristics@25°C

Part Number	Stand-off Voltage V _{wm} (V) Max	Breakdown Voltage V _{BR} @1mA (V) Min	Clamping Voltage V _c @ 1 A (V) Max	Leakage Current I _R @ V _{wm} (uA) Max	Capacitance (f = 1MHz) C @ 0V (pF) Max
SMDA03	3.3	4	7	200	800
SMDA05	5.0	6	9.8	20	600
SMDA12	12.0	13.3	19	1	185
SMDA15	15.0	16.7	24	1	140
SMDA24	24.0	26.7	43	1	90
SMDA36	36.0	40.0	51	1	80

Ratings and Characteristics Curves

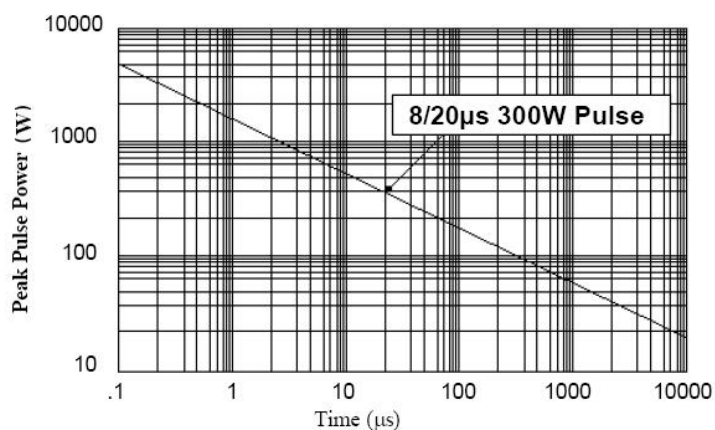


Figure 1. Peak Pulse Power Vs Pulse Time (µs)

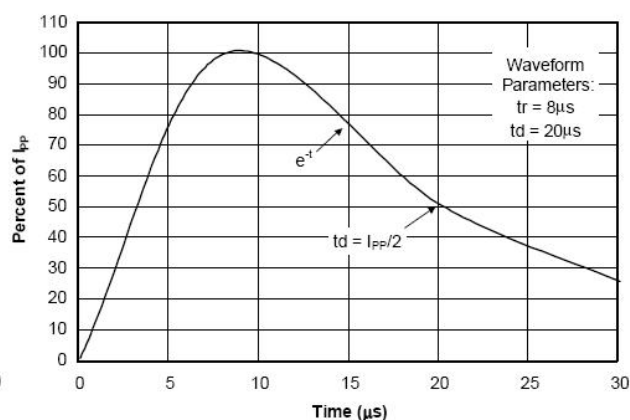


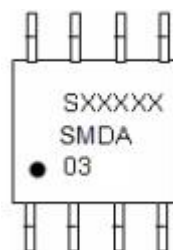
Figure 2. Pulse Wave Form

Ordering Information

Device	Package	Shipping
SMDA03 THRU SMDA36	SO-8 (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

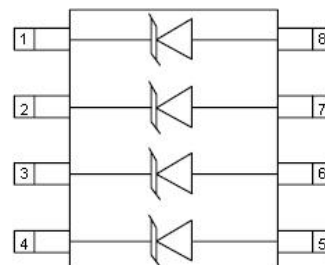
SMDA03 = Part Number
S = S
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

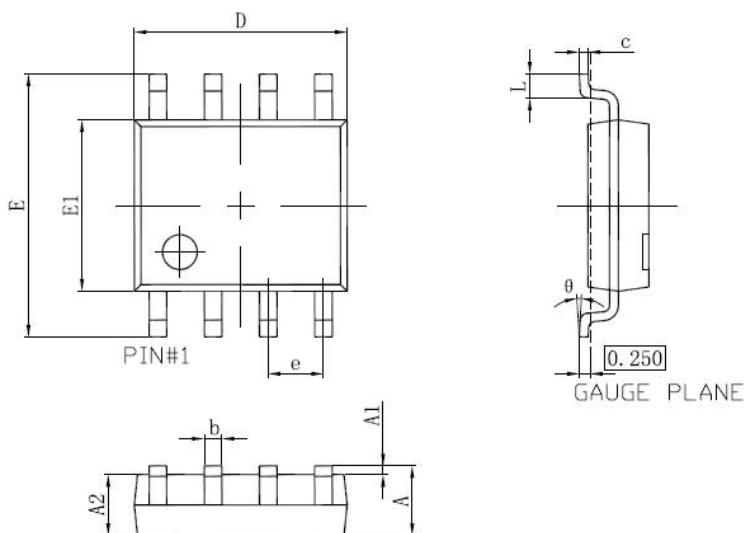
Circuit Diagram

The SMDAxx series of devices are designed to protect up to four data lines. The devices are connected as follows:

- ✓ The SMDAxx are unidirectional devices and are designed for use on line where the normal operating voltage is above ground. Pins 1, 2, 3, and 4 are connected to the protected lines. Pins 5, 6, 7, and 8 are connected to ground. The ground connections should be made directly to the ground plane for best results. The path length is kept as short as possible to reduce the effects of parasitic inductance in the board traces.

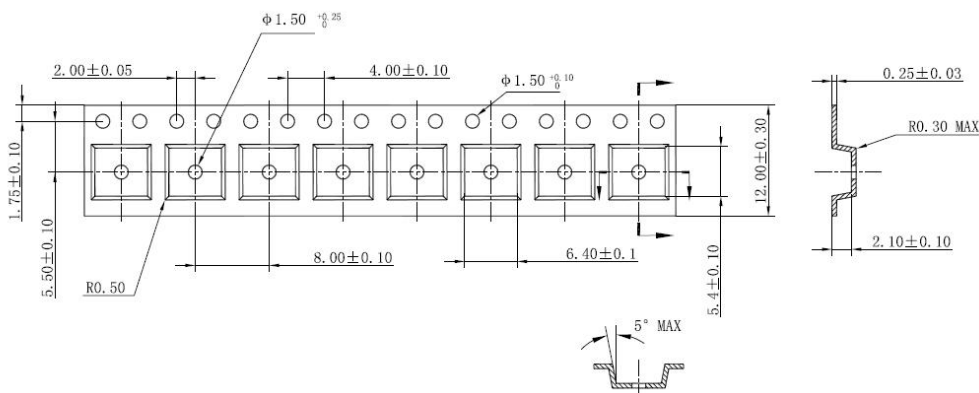


Mechanical Dimensions SO-8



SYMBOL	Millimeters		Inches	
	MIN.	MAX.	MIN.	MAX.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.031
θ	0°	8°	0°	8°

Carrier Tape Specification SO-8



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